

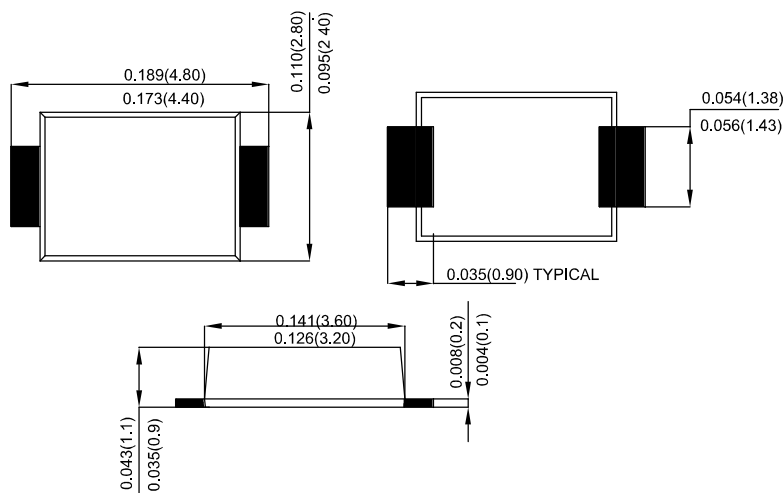
Features

- For surface mounted application
- Low forward voltage drop
- High current capability
- High reliability
- Classification Rating 94V- 0

Mechanical Data

- Case: Moeded plastic SMAF
- Terminals: Plated leads solderable per MIL-STD-750,Method 2026 guaranteed
- Polarity: Color band dentes cathode end
- Mounting Position: Any
- Making: Type Number

SMAF



Dimiensions in inches and (millimeters)

Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified

Single phase,half wave,60Hz,resistive or inductive load

For capacitive load derate current by 20%

Type Number	SYMBOL	G1AN	G1BN	G1DN	G1GN	G1JN	G1KN	G1MN	Unit
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	V
Average Rectified Output Current @T _A =75 °C	I _O	1.0							A
Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	30							A
Forward Voltage @IF=1.0A	V _{FM}	1.1							V
Peak Reverse Current @T _A =25 °C	I _R	5.0							uA
At Rated DC Blocking Voltage @T _A =100 °C		500							
Typical Junction Capacitance (Note 1)	C _J	12							pF
Typical Thermal Resistance Junction to Ambient(Note 2)	R _{θ JA}	30							°C/W
Operating Temperature Range	T _J	-55 to+150							°C
Storage Temperature Range	T _{STG}	-55 to +150							°C

Note: 1. Measured at 1.0 MHz and Applied reverse Voltage of 4.0V D.C

2. Resistance from Junction to Ambient at 0.375(9.5mm) lead length .

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

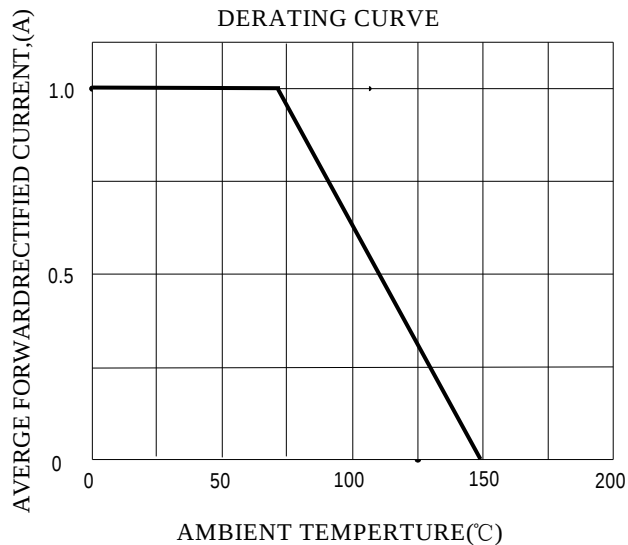


FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

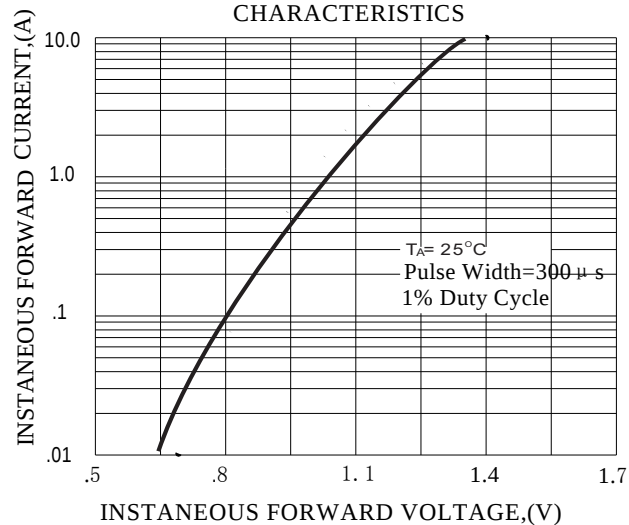


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

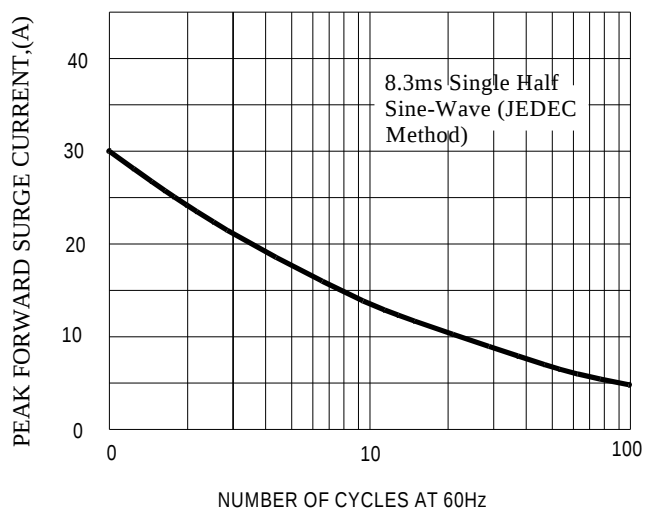


FIG.4-TYPICAL REVERSE CHARACTERISTICS

